

Multilayer Ceramic Chip Capacitor

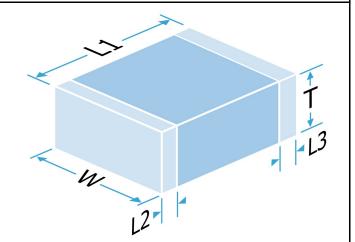
Part Number: 1812Y1K20104MXTWS3

Description: 1812 1200Vdc 100nF ±20% X7R (2R1)

A range of X7R MLC capacitors to suit a variety of applications. In a wide selection of chip sizes, rated voltages and terminations, including FlexiCap[™], the world's first commercially available flexible termination.

WS2 and WS3 parts use StackiCap™ patented construction technology.

Suffix code PXX or PX mandates the use of precious metal electrode (PME) materials. This may incur additional costs.



Mechanical Specification		
Size Code	1812	
Length (L1) in mm (")	4.6 ± 0.4 (0.181 ± 0.016)	
Width (W) in mm (")	3.2 ± 0.20 (0.126 ± 0.008)	
Thickness (T) in mm (")	3.5 Max (0.138 Max)	
Minimum Termination Band (L2,L3) in mm (")	0.25 (0.010)	
Maximum Termination Band (L2,L3) in mm (")	1.143 (0.045)	
Termination Material	FlexiCap [™] Polymer termination, Nickel barrier, Sn Plated Solder (RoHS compliant)	
Solderability	IEC-60068-2-58	
Packaging	7" Reel Horizontal Orientation, 500 per reel	
Conformal Coating	Considered essential and was used for internal qualification testing	

General Electrical Specification			
Rated Voltage		1200Vdc	
Nominal Capacitance Value		100nF	
Capacitance Tolerance		±20%	
Tangent of Loss Angle (Tan δ)		≤0.025	
Capacitance and Tan δ Test Conditions		1.0Vrms @ 1kHz	
Voltage Proof (Voltage applied for 5 secs max. @ 50mA max. charge current)		1440Vdc	
Min Insulation Resistance (IR)		5.00GOhm @ 100V	/dc
Dielectric Classification		X7R (2R1)	
Rated Temperature Range		-55°C / +125°C	
Maximum Capacitance Change over Temperature Range		No DC Voltage Rated DC Voltage	±15% -
Climatic Category (IEC)		55/125/56	
Ageing Characteristic		<2% per decade (no	ominal capacitance is 1000 hour value)
Knowles Precision Devices - Sales	This datasheet is for a standard item and is confirmed valid on the date generated, the latest published data for this part may differ and is available at http://www.knowlescapacitors.com or by contacting us.		
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Asia: KPD-Asia-sales@knowles.com	© The information contained on this drawing is confidential and may not be copied in whole or part in any form or disclosed to a third party without the consent of Knowles and any customer mentioned within this specification. Data is correct to the best of our knowledge, errors and omissions excepted. Data: Data is correct to the best of our knowledge, errors and omissions excepted. Data: Correct to the best of our knowledge, errors and omissions excepted. Data: Correct to the best of our knowledge, errors and omissions excepted. Data: Correct to the best of our knowledge, errors and omissions excepted. Data: Correct to the best of our knowledge, errors and omissions excepted. Data: Correct to the best of our knowledge, errors and omissions excepted. Data: Correct to the best of our knowledge, errors and omissions excepted. Data: Correct to the best of our knowledge, errors and omissions excepted. Data: Correct to the best of our knowledge, errors and omissions excepted. Data: Correct to the best of our knowledge, errors and omissions excepted. Data: Correct to the best of our knowledge, errors and omissions excepted. Data: Correct to the best of our knowledge, errors and omissions excepted. Data: Correct to the best of our knowledge, errors and omissions excepted. Data: Correct to the best of our knowledge, errors and omissions excepted. Data: Correct to the best of our knowledge, errors and omissions excepted. Data: Correct to the best of our knowledge, errors and omissions excepted.		
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www.knowlescapacitors.com			20221208 172811536UTC



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Part Number: 1812Y1K20104MXTWS3	Description: 1812 1200Vdc 100nF ±20% X7R (2R1)
Enviro	onmental
RoHS Compliant to 2011/65/EC as amended by 2015/863/EU	Compliant
REACH Compliant	224 compliant
California Proposition 65	No exposure risk
Board	I Layout
IPC-7351 pad design	
Knowles' conventional 2-terminal chip capacitors can generally be mounted using pad designs in accordance with international specification IPC-7351, Generic Requirements for Surface Mount Design and Land Pattern Standards, but there are some other factors that have been shown to reduce mechanical stress, such as reducing the pad width to less than the chip width. In addition, the position of the chip on the board should be considered. Some high voltage parts may require modifications to the board layout and/or the addition of a conformal coating to prevent flashover. Refer to application note AN0043 for	Image: Constraint of the second se
further information.	C
Paci	kaging
Tape packaging information for tape-and-reel parts: Tape and reel packing of surface mounting chip capacitors for automatic placement are in accordance with IEC60286-3.	Product identifying label Plastic carrier tape Top tape 8 or 12mm 178mm (7") or nominal 330mm (13") dia. reel
Solo	dering
Reflow solder in accordance with IPC-A-610. Recommended reflow profile as laid down in IPC/JEDEC J-STD-020. Wave soldering is also possible, but care must be taken for case sizes 1210 and larger and component thickness >1.0mm. Trials are encouraged. Hand soldering is not recommended and can lead to component damage through thermal shock. PdAg terminations are primarily intended for conductive epoxy	T _p T _L Max Min T _s Preheat area
attachment - they may be suitable for soldering but trials are recommended. Application notes with mounting and handling guidance are av	Time
Compex DLI Johanson MFG	Novacap Syfer Voltronics
Knowles Precision Devices - Sales Europe: KPD-Europe-sales@knowles.com	standard item and is confirmed valid on the date generated, the latest published da and is available at http://www.knowlescapacitors.com or by contacting us.
USA: KPD-NA-sales@knowles.com any form or disclosed to a	tained on this drawing is omissions excepted. third party without the consent tomer mentioned within this Date: Thursday, December 08, 2022 20221208 172811536UTC